

To: **Technology Unit: TBD**
Facsimile Number: 703-872-9306

Total Pages Sent 7

From: **W. Daniel Swayze, Jr.**
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5633

RECEIVED
 CENTRAL FAX CENTER

JUL 13 2004

FACSIMILE COVER SHEET

OFFICIAL

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at **703-872-9306** on the date shown below:

Tommie Chambers July 13, 2004
 Tommie Chambers Date

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT/PRELIMINARY (6 Pages)																												
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT (# Month)																												
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL																												
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)																												
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)																												
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> PETITION TO REVIVE																												
<input type="checkbox"/> CONTINUATION APP'N (# Pages)																													
<input type="checkbox"/> DIVISIONAL APP'N																													
<table border="1"> <tr> <td colspan="2">NAME OF INVENTOR(S): Heisley</td> <td colspan="2">RECEIPT DATE & SERIAL NO.:</td> </tr> <tr> <td colspan="2">TITLE OF INVENTION: WAFER ALIGNMENT DEVICE AND METHOD</td> <td colspan="2">Serial No.: 10/792,185</td> </tr> <tr> <td colspan="2">TI FILE NO.: TI-33886.1</td> <td colspan="2">Filing Date: 3/2/2004</td> </tr> <tr> <td colspan="2">DEPOSIT ACCT. NO.: 20-0668</td> <td colspan="2"></td> </tr> <tr> <td colspan="2">FAXED: 07/13/2004</td> <td colspan="2"></td> </tr> <tr> <td colspan="2">DUE: 07/17/2004</td> <td colspan="2"></td> </tr> <tr> <td colspan="2">ATTY/SECY: WDS/nc</td> <td colspan="2"></td> </tr> </table>		NAME OF INVENTOR(S): Heisley		RECEIPT DATE & SERIAL NO.:		TITLE OF INVENTION: WAFER ALIGNMENT DEVICE AND METHOD		Serial No.: 10/792,185		TI FILE NO.: TI-33886.1		Filing Date: 3/2/2004		DEPOSIT ACCT. NO.: 20-0668				FAXED: 07/13/2004				DUE: 07/17/2004				ATTY/SECY: WDS/nc			
NAME OF INVENTOR(S): Heisley		RECEIPT DATE & SERIAL NO.:																											
TITLE OF INVENTION: WAFER ALIGNMENT DEVICE AND METHOD		Serial No.: 10/792,185																											
TI FILE NO.: TI-33886.1		Filing Date: 3/2/2004																											
DEPOSIT ACCT. NO.: 20-0668																													
FAXED: 07/13/2004																													
DUE: 07/17/2004																													
ATTY/SECY: WDS/nc																													

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
 PO Box 655474, M/S 3999
 Dallas, TX 75265

RECEIVED
CENTRAL FAX CENTER
JUL 13 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

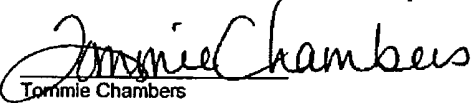
Heisley
Serial No.: TBD
Filed: 3/2/2004
For: WAFER ALIGNMENT DEVICE AND METHOD

Docket No.: TI-33886.1
Examiner: TBD
Art Unit: TBD

OFFICIAL

PRELIMINARY AMENDMENT

Honorable Assistant Commissioner
of Patents
Washington, D.C. 20231

<p>CERTIFICATION OF FACSIMILE TRANSMISSION</p> <p>I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on <u>7-13-04</u>:</p> <p> Tommie Chambers</p>
--

Responsive to the Notice of Non-Compliant Amendment mailed June 17, 2004, in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.